

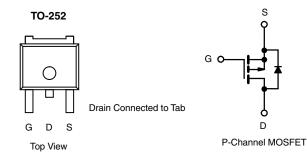
CEU30P10-VB Datasheet P-Channel 100 V (D-S) MOSFET

PRODUCT SUMMARY					
V _{DS} (V)	- 100				
$R_{DS(on)}(\Omega)$ at $V_{GS} = -10 \text{ V}$	0.033				
$R_{DS(on)}(\Omega)$ at $V_{GS} = -4.5 \text{ V}$	0.037				
I _D (A)	- 40				
Configuration	Single				

FEATURES

- Halogen-free According to IEC 61249-2-21 Definition
- Trench Power MOSFET
- Package with Low Thermal Resistance
- 100 % R_g and UIS Tested
- Compliant to RoHS Directive 2002/95/EC





ABSOLUTE MAXIMUM RATINGS (T _C = 25 °C, unless otherwise noted)						
PARAMETER	SYMBOL	LIMIT	UNIT			
Drain-Source Voltage		V _{DS}	- 100	V		
Gate-Source Voltage	V _{GS}	± 20	v			
Continuous Drain Current	T _C = 25 °C	1	- 40			
Continuous Drain Current	T _C = 125 °C	- I _D	- 22			
Continuous Source Current (Diode Conduction) ^a		I _S	- 50	Α		
Pulsed Drain Current ^b		I _{DM}	- 150			
Single Pulse Avalanche Current	L = 0.1 mH	I _{AS}	- 44			
Single Pulse Avalanche Energy	L = 0.1 min	E _{AS}	96	mJ		
Maximum Power Dissipation ^b	T _C = 25 °C	- P _D	136	W		
	T _C = 125 °C		45] vv		
Operating Junction and Storage Temperature Range		T _J , T _{stg}	- 55 to + 175	°C		

THERMAL RESISTANCE RATINGS					
PARAMETER		SYMBOL	LIMIT	UNIT	
Junction-to-Ambient	PCB Mount ^c	R_{thJA}	50	°C/W	
Junction-to-Case (Drain)		R _{thJC}	1.1	C/ VV	

Notes

- a. Package limited.
- b. Pulse test; pulse width \leq 300 μ s, duty cycle \leq 2 %.
- c. When mounted on 1" square PCB (FR-4 material).
- d. Parametric verification ongoing.

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SPECIFICATIONS ($T_C = 25 ^{\circ}C$,		1		MIN.			
PARAMETER	SYMBOL	TES	TEST CONDITIONS		TYP.	MAX.	UNIT
Static	<u> </u>	1			1	T	
Drain-Source Breakdown Voltage	V _{DS}	$V_{GS} = 0 \text{ V}, I_D = -250 \mu\text{A}$		- 100	-	-	V
Gate-Source Threshold Voltage	V _{GS(th)}		$V_{DS} = V_{GS}, I_D = -250 \mu A$		-	-2.5	·
Gate-Source Leakage	I _{GSS}	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 20 \text{ V}$		-	-	± 100	nA
		$V_{GS} = 0 V$	V _{DS} = - 100 V	-	-	- 1	μΑ
Zero Gate Voltage Drain Current	I _{DSS}	$V_{GS} = 0 V$	V _{DS} = - 100 V, T _J = 125 °C	-	-	- 50	
		$V_{GS} = 0 V$	V _{DS} = - 100 V, T _J = 175 °C	-	-	- 250	
On-State Drain Current ^a	I _{D(on)}	V _{GS} = - 10 V	$V_{DS} \le -5 V$	- 30	-	-	Α
		V _{GS} = - 10 V	I _D = - 9.2 A	-	0.033	-	- Ω
Drain-Source On-State Resistance ^a	R _{DS(on)}	V _{GS} = - 10 V	I _D = - 9.2 A, T _J = 125 °C	-	0.065	-	
Drain-Source On-State Resistance	T (DS(on)	$V_{GS} = -10 \text{ V}$	I _D = - 9.2 A, T _J = 175 °C	-	0.081	-	
		$V_{GS} = -4.5 \text{ V}$	I _D = - 7.7 A	-	0.037	-	
Forward Transconductance ^b	9fs	V _{DS} = - 15 V, I _D = - 9.2 A		-	35	-	S
Dynamic ^b							
Input Capacitance	C _{iss}			-	4433	-	
Output Capacitance	C _{oss}	$V_{GS} = 0 \text{ V}$ $V_{DS} = -25 \text{ V}, f = 1 \text{ MHz}$	-	301	-	рF	
Reverse Transfer Capacitance	C _{rss}			-	208	-	1
Total Gate Charge ^c	Qg		V _{DS} = - 50V, I _D = - 9.2 A	-	96	144	
Gate-Source Charge ^c	Q _{gs}	V _{GS} = - 10 V		-	8.4	-	nC
Gate-Drain Charge ^c	Q _{gd}	1		-	23.5	-	1
Gate Resistance	R _g	f = 1 MHz		1.5	3.13	4.7	Ω
Turn-On Delay Time ^c	t _{d(on)}				11	17	
Rise Time ^c	t _r	$V_{DD} = 50 \text{ V}, \text{R}_{\text{L}} = \text{6.49 } \Omega$ $I_{D} \cong 7.7 \text{ A}, \text{V}_{\text{GEN}} = 10 \text{ V}, \text{R}_{\text{g}} = \text{1.0 } \Omega$		-	11	17	ns
Turn-Off Delay Time ^c	t _{d(off)}			-	78	117	
Fall Time ^c	t _f			-	15	23	
Source-Drain Diode Ratings and Characteristics ^b							
Pulsed Current ^a	I _{SM}			-	-	- 150	Α
Forward Voltage	V _{SD}	I _F = - 7.7 A, V _{GS} = 0 V		-	- 0.8	- 1.5	V

Notes

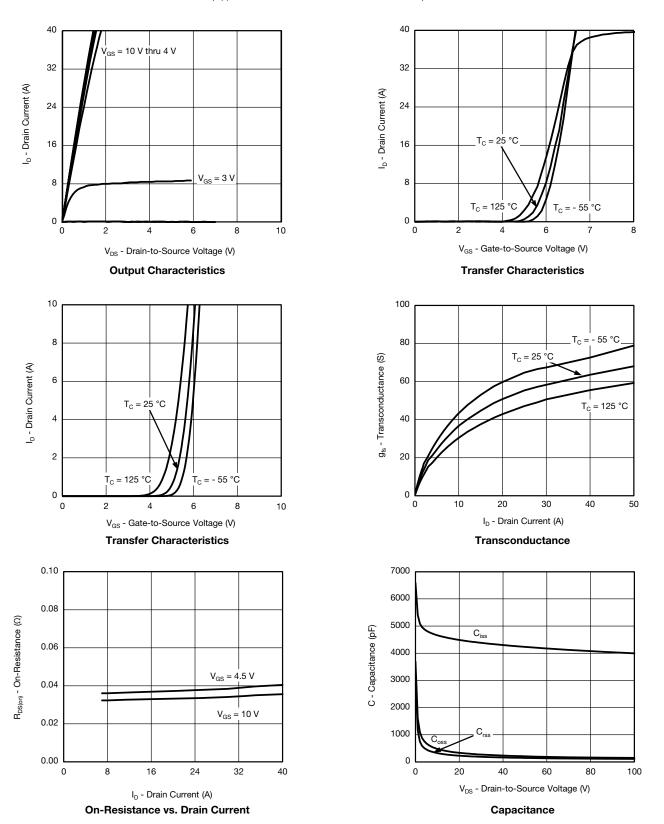
- a. Pulse test; pulse width $\leq 300~\mu s,$ duty cycle $\leq 2~\%.$
- b. Guaranteed by design, not subject to production testing.
- c. Independent of operating temperature.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

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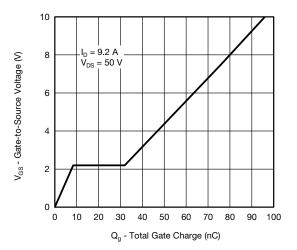
TYPICAL CHARACTERISTICS ($T_A = 25$ °C, unless otherwise noted)



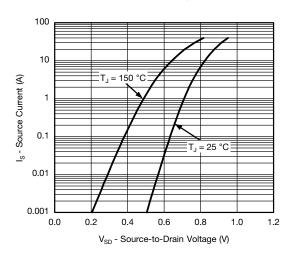
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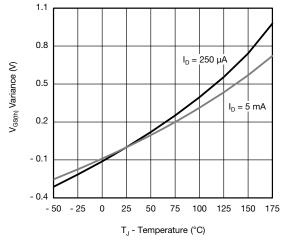
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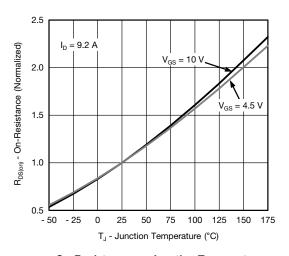
Gate Charge



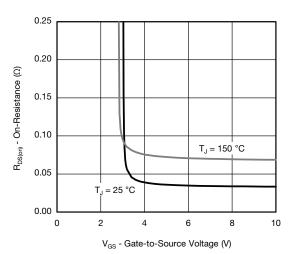
Source Drain Diode Forward Voltage



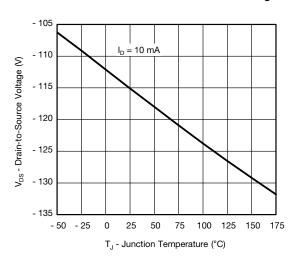
Threshold Voltage



On-Resistance vs. Junction Temperature



On-Resistance vs. Gate-to-Source Voltage

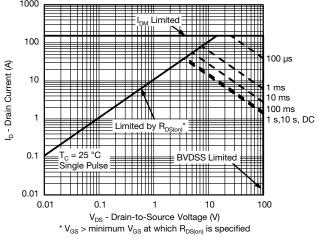


Drain Source Breakdown vs. Junction Temperature

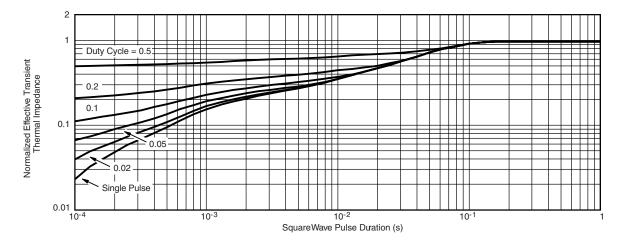
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THERMAL RATINGS ($T_A = 25$ °C, unless otherwise noted)



Safe Operating Area

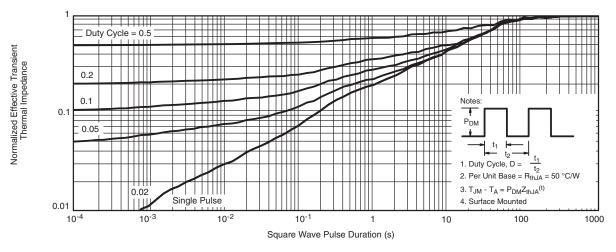


Normalized Thermal Transient Impedance, Junction-to-Case

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THERMAL RATINGS (T_A = 25 °C, unless otherwise noted)



Normalized Thermal Transient Impedance, Junction-to-Ambient

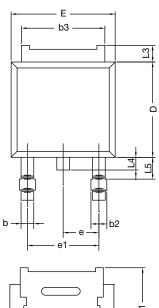
Note

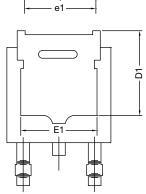
- The characteristics shown in the two graphs
 - Normalized Transient Thermal Impedance Junction to Ambient (25 °C)
 - Normalized Transient Thermal Impedance Junction to Case (25 °C) are given for general guidelines only to enable the user to get a "ball park" indication of part capabilities. The data are extracted from single pulse transient thermal impedance characteristics which are developed from empirical measurements. The latter is valid for the part mounted on printed circuit board FR4, size 1" x 1" x 0.062", double sided with 2 oz. copper, 100 % on both sides. The part capabilities can widely vary depending on actual application parameters and operating conditions.

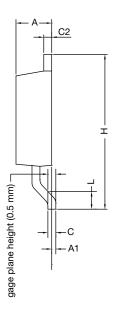
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TO-252AA Case Outline







	MILLIN	METERS	INC	HES		
DIM.	MIN.	MAX.	MIN.	MAX.		
Α	2.18	2.38	0.086	0.094		
A1	-	0.127	-	0.005		
b	0.64	0.88	0.025	0.035		
b2	0.76	1.14	0.030	0.045		
b3	4.95	5.46	0.195	0.215		
С	0.46	0.61	0.018	0.024		
C2	0.46	0.89	0.018	0.035		
D	5.97	6.22	0.235	0.245		
D1	4.10	-	0.161	-		
Е	6.35	6.73	0.250	0.265		
E1	4.32	-	0.170	-		
Н	9.40	10.41	0.370	0.410		
е	2.28	BSC	0.090	BSC		
e1	4.56 BSC		0.180 BSC			
L	1.40	1.78	0.055	0.070		
L3	0.89	1.27	0.035	0.050		
L4	-	1.02	-	0.040		
L5	1.01	1.52	0.040	0.060		
ECN: T13-0592-Rev. A, 02-Sep-13						

DWG: 6019

Note

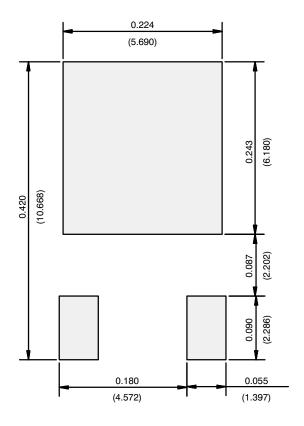
• Dimension L3 is for reference only.

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RECOMMENDED MINIMUM PADS FOR DPAK (TO-252)



Recommended Minimum Pads Dimensions in Inches/(mm)

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